
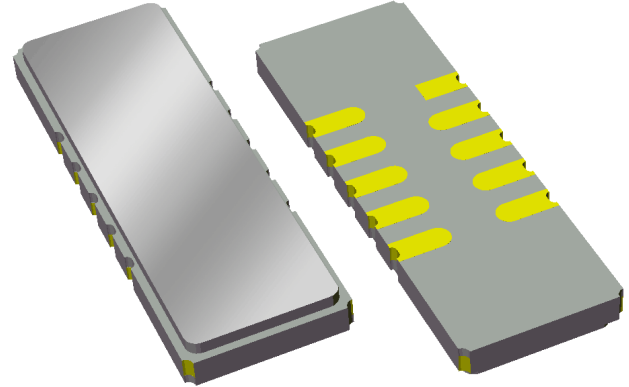


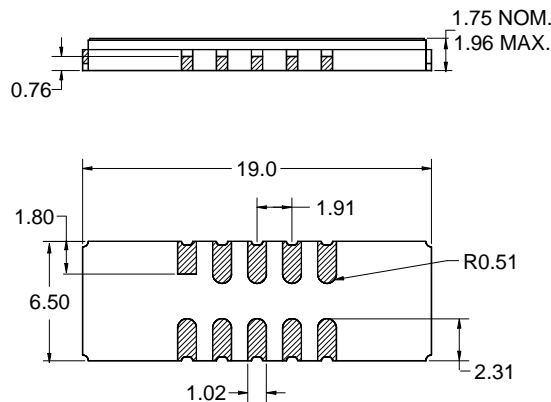
## Features

- For broadband applications
- Typical 3 dB bandwidth of 4.9 MHz
- High attenuation
- Single-ended operation
- Ceramic Surface Mount Package (SMP)
- Replaces Sawtek P/N 851551 (BW 3dB=4.5 MHz)
- Hermetic
- **RoHS** compliant (2002/95/EC), **Pb-free** 



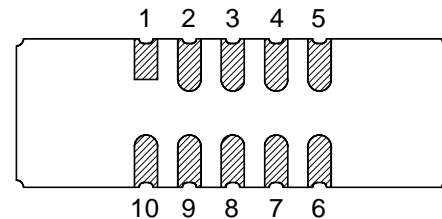
## Package

Surface Mount 19.00 x 6.50 x 1.75 mm  
SMP-75B



## Pin Configuration

Bottom View



### Single-ended Configuration

Pin No.	Description
5	RF output
10	RF Input
1,6	Ground
2,3,4	Case Ground
7,8,9	Case Ground

Dimensions shown are nominal in millimeters  
All tolerances are  $\pm 0.15$  mm except overall  
length and width  $\pm 0.10$  mm

Body:  $Al_2O_3$  ceramic  
Lid: Kovar, Ni plated  
Terminations: Au plating 0.5 - 1.0  $\mu$ m,  
over a 2 - 6  $\mu$ m Ni plating

## Electrical Specifications <sup>(1)</sup>

Operating Temperature Range: <sup>(2)</sup> 0 to +70 °C

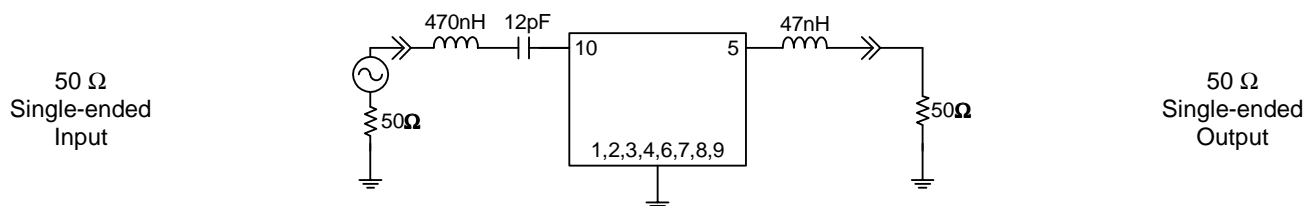
Parameter <sup>(3)</sup>	Minimum	Typical <sup>(4)</sup>	Maximum	Unit
Center Frequency	-	70	-	MHz
Minimum Insertion Loss	-	23.7	25.5	dB
Lower 1 dB Bandedge <sup>(5)</sup>	-	67.74	67.9	MHz
Upper 1 dB Bandedge	72.1	72.31	-	MHz
Lower 3 dB Bandedge <sup>(5)</sup>	-	67.53	67.65	MHz
Upper 3 dB Bandedge	72.35	72.50	-	MHz
Lower 40 dB Bandedge <sup>(5)</sup>	66.68	66.79	-	MHz
Upper 40 dB Bandedge	-	73.20	73.32	MHz
Amplitude Variation 67.9 - 72.1 MHz	-	0.71	1.15	dB p-p
Phase Linearity 67.9 - 72.1 MHz	-	3.3	5.85	deg p-p
Group Delay Variation 67.9 - 72.1 MHz	-	60	135	nsec
Absolute Delay	-	2.3	-	μsec
Relative Attenuation <sup>(5)</sup>				
10 - 58 MHz	42.0	54	-	dB
58 - 65 MHz	36.5	45	-	dB
75 - 82 MHz	42.0	45	-	dB
82 - 124 MHz	42.5	53	-	dB
124 - 140 MHz	37.5	46	-	dB
140 - 200 MHz	50.0	63	-	dB
Source Impedance <sup>(6)</sup>	-	50	-	Ω
Load Impedance <sup>(6)</sup>	-	50	-	Ω

### Notes:

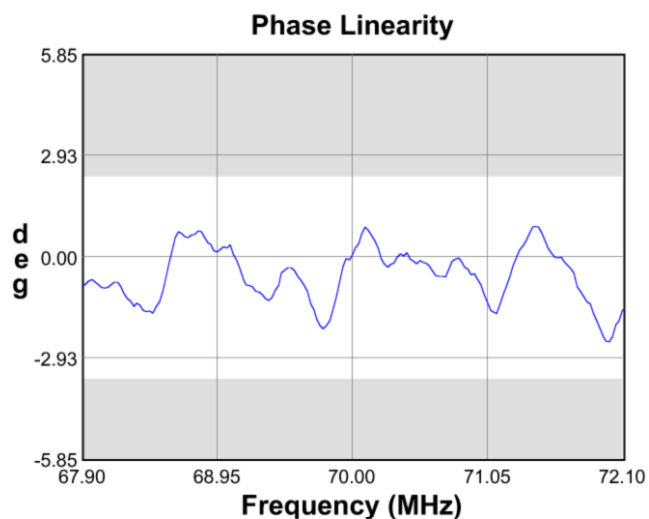
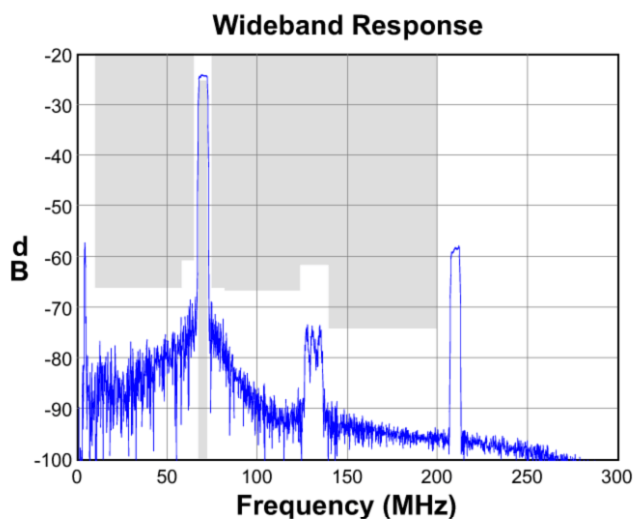
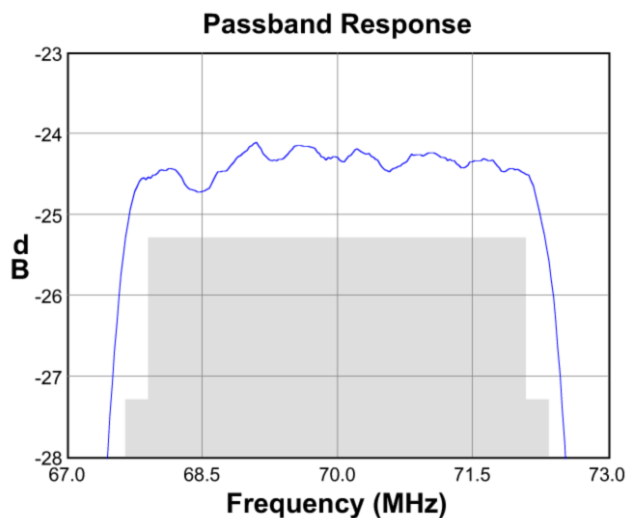
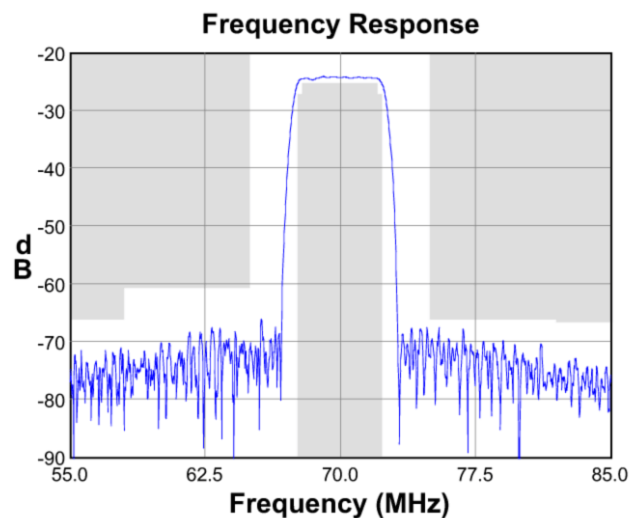
1. All specifications are based on the matching schematic shown below
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
4. Typical values are based on average measurements at room temperature
5. All attenuation measurements are measured relative to minimum insertion loss
6. This is the optimum impedance in order to achieve the performance shown

### Test Circuit:

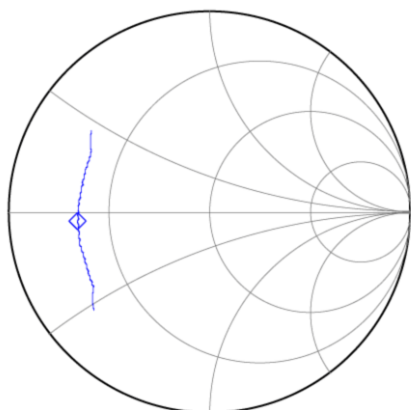
Actual matching values may vary due to PCB layout and parasitics



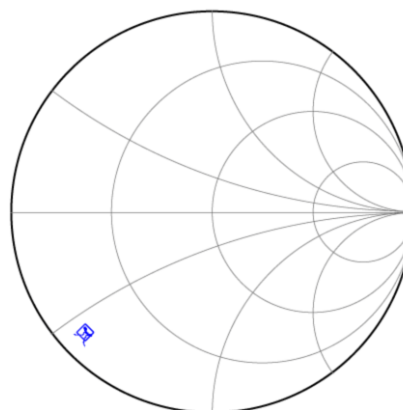
**Typical Performance (at room temperature)**



**Input Smith Chart**

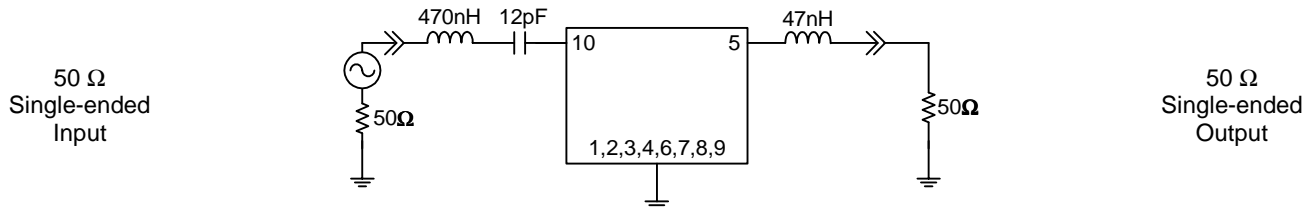


**Output Smith Chart**

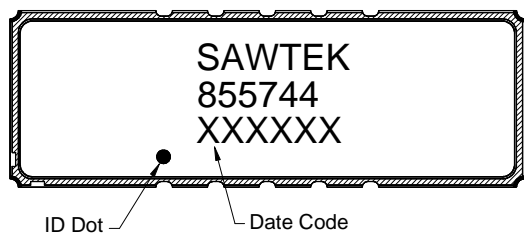


## Matching Schematics

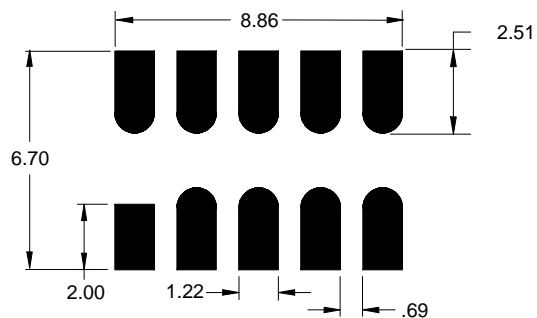
Actual matching values may vary due to PCB layout and parasitics



## Marking



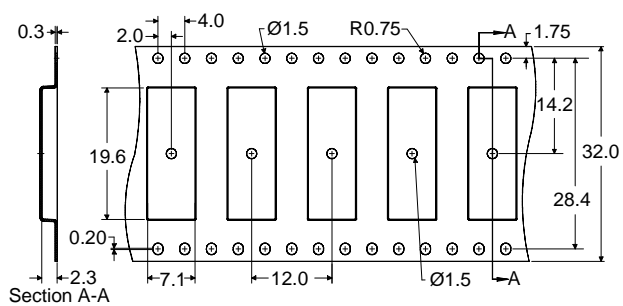
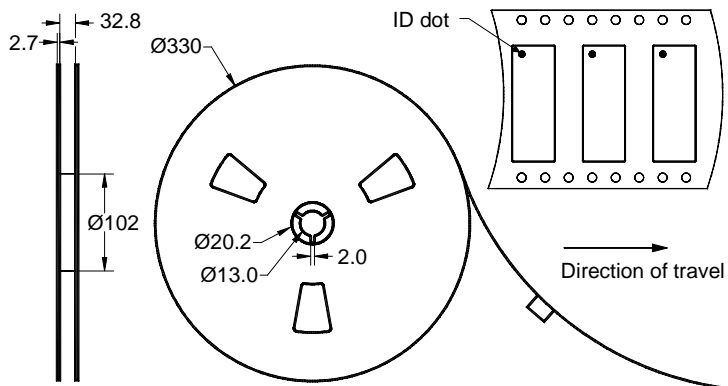
## PCB Footprint



The date code consists of: day of the current year (Julian, 3 digits), last digit of the year (1 digit) and hour (2 digits)

This footprint represents a recommendation only  
Dimensions shown are nominal in millimeters

## Tape and Reel




Dimensions shown are nominal in millimeters  
Packaging quantity: 2000 units/reel

## Maximum Ratings


Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	0	+70	°C
Storage Temperature Range	T <sub>stg</sub>	-40	+85	°C

## Important Notes

### Warnings

- Electrostatic Sensitive Device (ESD) 
- Avoid ultrasonic exposure

### RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS) 

### Solderability

- Compatible with JESD22-B102, Pb-free process, 260C peak reflow temperature ([see soldering profile](#))

## Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

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